



## Product Change Notification: CENO-02VUYS211

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### Date:

20-Feb-2025

### Product Category:

Crypto Memory, Crypto RF

### Notification Subject:

CCB 6562 Final Notice: Qualification of UID as an additional assembly site for AT88SC0808CRF-MX1, AT88SC1616CRF-MX1, AT88SC3216CRF-MX1, AT88RF04C-MX1G, AT88WJ008-MX1G, AT88WJ010-MX1G and AT88SC6416CRF-MX1 catalog part numbers (CPN) available in SCNC Smart Card (12.6x12.6x0.58mm) package.

### Affected CPNs:

**[CENO-02VUYS211\\_Affected\\_CPN\\_02202025.pdf](#)**  
**[CENO-02VUYS211\\_Affected\\_CPN\\_02202025.csv](#)**

**PCN Status:** Final Notification

**PCN Type:** Manufacturing Change

**Microchip Parts Affected:** Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:** Qualification of UID as an additional assembly site for AT88SC0808CRF-MX1, AT88SC1616CRF-MX1, AT88SC3216CRF-MX1, AT88RF04C-MX1G, AT88WJ008-MX1G, AT88WJ010-MX1G and AT88SC6416CRF-MX1 catalog part numbers (CPN) available in SCNC Smart Card (12.6x12.6x0.58mm) package.

### Pre and Post Summary Changes:

	Pre Change	Post Change	
Assembly Site	AIC Semiconductor Sdn Bhd	AIC Semiconductor Sdn Bhd	UTAC Indonesia (UID)

		(AIC)	(AIC)	
<b>Wire Material</b>		Au	Au	Au
<b>Die Attach Material</b>		2035SC	2035SC	2035SCR
<b>Molding Compound Material</b>	<b>Dam</b>	DF698	DF698	DF6982
	<b>Fill</b>	4670	4670	DF6958
<b>Lead-Frame Material</b>		Epoxy Glass Film base with Copper	Epoxy Glass Film base with Copper	Epoxy Glass Film base with Copper
<b>Shipping Media</b>  <b>Plastic Reel</b>	<b>Dimension</b>	With minor dimensional changes. See pre and post change for comparison.		
	<b>Color</b>	Black	Black	Black

**Impacts to Datasheet:** None

**Change Impact:** None

**Reason for Change:** To improve on-time delivery performance by qualifying UID as an additional assembly site.

**Change Implementation Status:** In Progress

**Estimated First Ship Date:** 31 March 2025 (date code: 2514)

**Note Below EFSD:** Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Timetable Summary:**

	January 2024				>	February 2025					March 2025				
Work Week	01	02	03	04		05	06	07	08	09	10	11	12	13	14
Initial PCN Issue Date	X														
Qual Report Availability									X						
Final PCN Issue Date									X						
Estimated Implementation Date															X

**Method to Identify Change:** Traceability Code

**Qualification Report:** Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:** January 06, 2024: Issued initial notification.

February 20, 2025: Issued final notification. Attached the qualification report. Provided estimated first ship date to be on March 31, 2025.

**Note:** The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

## Attachments:

**PCN\_CENO-02VUYS211\_Pre and Post Change\_Summary.pdf**

**PCN\_CENO-02VUYS211\_Qual\_Report.pdf**

Please contact your local **Microchip sales office** with questions or concerns regarding this notification.

## Terms and Conditions:

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If you wish to change your PCN profile, including opt out, please go to the **PCN home page** select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.